

Design of a 4 GHz LNA for a TVRO System

Application Note A002

Introduction

With the advent of low cost GaAs FETs, the consumer home entered a new phase in communications: the era of satellite television reception. A typical Television Receive Only (TVRO) system for this market is shown in Figure 1. The consumer end of this system consists of an antenna to receive the satellite signal, a low noise amplifier or LNA to amplify the signal received by the antenna to a high enough level that it can be processed, a converter to change the frequency of the amplified signal from the satellite broadcast frequency to the frequency band in which the TV receiver operates, and a TV receiver to translate the signal into electrical impulses that will be changed into pictures and sound by the consumer's television set.

This note describes the design of a six stage LNA for such a system. The operating frequency of this LNA is 3.7 – 4.2 GHz, the most common band in the United States.

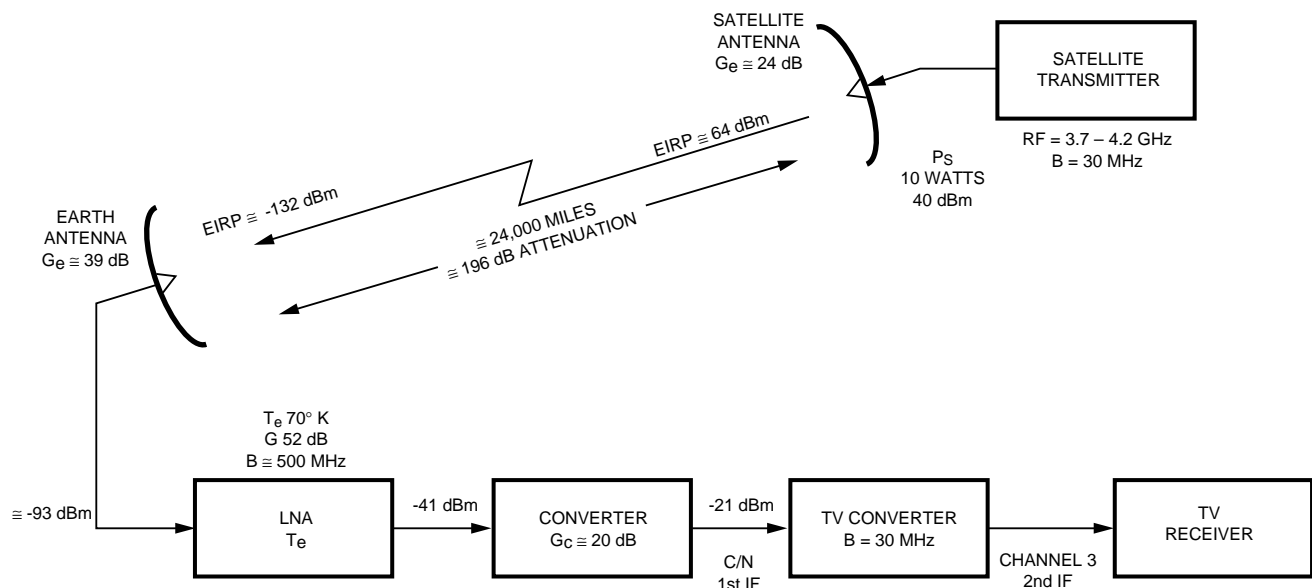


Figure 1. Satellite RF Down-Link Diagram for TVRO System with Typical System Parameters

LNA Specifications

The quality of the TV picture produced by a TVRO system is determined by the ratio of the gain of the earth antenna to the effective input noise temperature of the system (noise temperature of LNA plus noise temperature of antenna). This ratio is called the G/T ratio. It is important to the consumer since it shows that picture quality can be improved in either of two ways. Using a higher gain antenna will raise the system G/T ratio, and hence result in a better picture. Similarly, using an LNA with a lower noise figure will also raise the G/T ratio.

In general, the gain of an antenna is proportional to its size. Unfortunately for the consumer, so is its cost. Since the antenna tends to be the most expensive part of the home TVRO system, the importance of an economical LNA with low noise figure is readily seen.

The G/T ratio can be expressed as a function of the ratio of carrier power (C) to noise power (N) at the receiver, the effective-isotropic-radiated-power of the satellite (EIRP), the down link loss (L_s), the link margin (L_m), and the transmission bandwidth (B). The mathematical relationship is given by:

$$10 \log (G/T) = C/N - EIRP + L_s + L_m + 10 \log(B) - 228.6 \text{ dB}$$

For a typical system,

C/N = 10 dB minimum for good picture quality
 satellite transmit power = 10 watts
 satellite antenna gain = 24 dB

so

EIRP = satellite transmit power + satellite antenna gain
 = 10 dBw + 24 dB
 = 34 dBw

distance to satellite = 38,559 km
 wavelength (for a 4 GHz system) = 0.075 m

so

$L_s = 20 \log [(4\pi) (\text{distance to satellite})/(\text{wavelength})]$
 = $20 \log [(4\pi) (38,559 \text{ km})/(0.075 \text{ m})]$
 = 196.2 dB

$L_m = 1 \text{ dB}$
 bandwidth = 30 MHz

so

$10 \log B = 10 \log (30 \times 10^6 \text{ Hz})$
 = 74.8 dB

therefore

$10 \log (G/T) = 10 - 34 + 196.2 + 1 + 74.8 - 228.6$
 = 19.4 dB

(see Appendix 1 for details of the above derivation)

Using this relationship, a plot of earth station antenna gain vs. system noise temperature was generated for a C/N ratio of 10 dB (Figure 2). By using the fact that most 4 GHz TVRO antennas have noise temperatures of about 25 K, this graph can be used to find the minimum noise temperature that an LNA must have to provide an acceptable picture

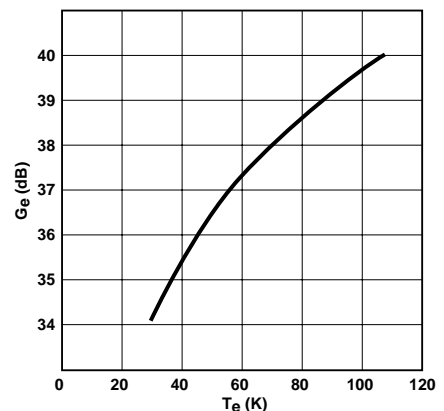


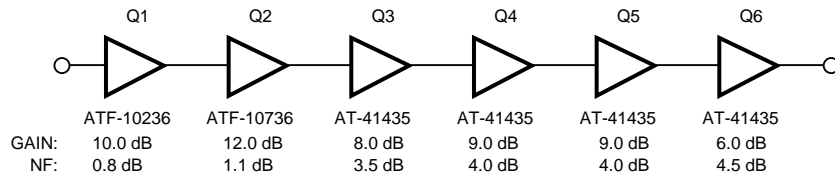
Figure 2. G_e vs. T_e for C/N = 10 dB

when coupled with an earth station antenna of a specified gain. For example, an antenna that has 39 dB of gain would require the LNA with which it is coupled to have a maximum noise temperature of (87-25) K or 62 K.

In addition to having a sufficiently low noise temperature, the LNA must also have enough gain to provide a signal strong enough to drive the converter. From the power levels shown in Figure 1, it can be seen that the LNA should have at least 52 dB of gain across the 3.7 – 4.2 GHz band.

Amplifier Design

The requirement that the LNA have minimal noise temperature dictates the use of GaAs FETs for the first two stages of the design. While GaAs FETs have superior noise performance to silicon bipolar transistors in the 4 GHz frequency range, they are also more expensive. In this design, the first two stages provide about 24 dB of gain. The remainder of the required 52 dB is made up of stages using lower cost silicon bipolars; to insure production margin four stages of silicon are used. The total amplifier chain is given in Figure 3.



NOTE:
The ATF-10736 has been
obsoleted. Please use the
ATF-10236 as a replacement.

NOTE: Q1 SELECTED FOR F_{min}

DESIGN GOALS:	NOISE FIGURE < 1.1 dB	PERFORMANCE:	TYPICAL GAIN 50-54 dB
	NOISE TEMPERATURE < 85 K		NOISE TEMPERATURE 60-85 K
	GAIN > 50 dB		
	OVERALL STABILITY		
	LOW COST		

Figure 3. 3.7 - 4.2 GHz Low Noise Amplifier

The device selected for use in stage 1 is the HP ATF-10236. The device can provide the required noise temperatures and gain at 4 GHz, and comes packaged in a cost saving glass sealed package, suitable for use in commercial markets. It has a typical noise figure of 0.8 dB; for stage 2 the less expensive HP ATF-10736 with a typical noise figure of 1.1 dB is used.

The design proceeds from the S-parameters listed on the ATF-10235 data sheet. These S-parameters are repeated in Figures 7 and 8. The noise parameters used for Q1 and Q2 are as follows:

Q1:	F_o	= 0.8 dB	Q2:	F_o	= 1.1 dB
	Γ_{on}	= $0.42 \angle 148^\circ$		Γ_{on}	= $0.43 \angle 152^\circ$
	R_n	= 3.6 Ohms		R_n	= 2.1 Ohms

where Γ_{on} is the reflection coefficient seen at the transistor input port for minimum noise figure. (Note: the noise contribution of a device may be expressed as either a noise figure in dB or a noise temperature in K. The relationship between these two measurements is shown in Figure 4.) A graph showing the total amplifier and system noise figures in K as a function of first stage noise figure in dB is shown in Figure 5.

The input network of Q1 is designed to match from a 50 Ω generator to Γ_{on}^* using lossless elements. Starting at Γ_{on}^* a series impedance of +j36 Ω brings the reflection coefficient to point A in Figure 6. This impedance is realized using a 1.43 nH inductor. Transforming to the admittance plane to point B, we find that an open stub of admittance j1.1 nS (normalized to 20 mS) will complete the match. The length of this stub is 0.132 λ_g . For a softboard substrate having an effective dielectric constant of 2.05, this translates to a physical length of:

$$l = \frac{0.132c}{f \times \sqrt{\epsilon_K}} = \frac{0.132 \times 3 \times 10^{10} \text{ cm/sec}}{3.95 \text{ GHz} \times 2.54 \text{ cm/in} \times \sqrt{2.05}} = 0.275 \text{ in}$$

Thus, the input design is simply a 50 Ω stub 275 mils long followed by an inductor of 1.4 nH. Notice that the series inductor can be realized using the gate lead of the transistor package.

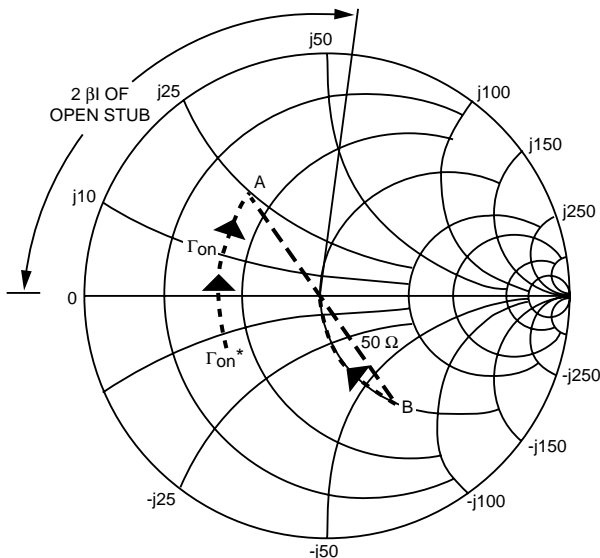


Figure 6. Input Network Design

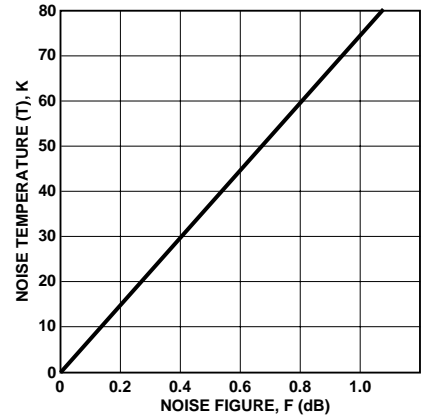


Figure 4. Noise Temperature vs. Noise Figure

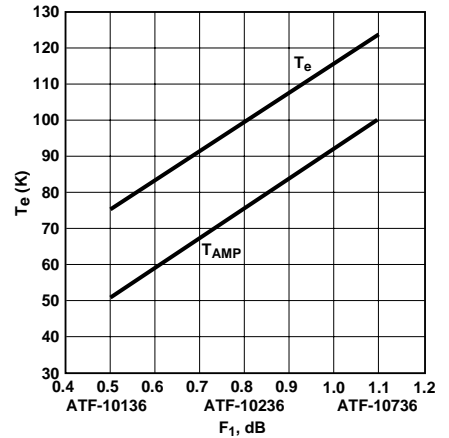


Figure 5. Effective Input Noise Temperature (T_e) vs. First Stage Noise Figure (F_1) ($T_{Ant} = 25 \text{ K}$)

!ATF-10236		S PARAMETERS			BIAS: Vds=2V, Ids=20mA				
!F	M[S11]	A[S11]	M[S21]	A[S21]	M[S12]	A[S12]	M[S22]	A[S22]	
2	.74	-78	4.99	107	.09	50	.37	-54	
3	.60	-105	4.17	82	.12	38	.34	-57	
4	.52	-142	3.65	56	.15	24	.26	-60	
5	.47	170	3.12	30	.17	7	.10	-51	
6	.53	128	2.62	5	.18	-7	.09	71	
7	.63	99	2.18	-15	.19	-20	.22	76	
8	.72	77	1.80	-33	.19	-31	.32	67	
9	.79	58	1.47	-50	.18	-43	.42	53	
10	.80	41	1.19	-67	.18	-47	.49	41	
11	.83	31	1.05	-80	.16	-64	.57	34	
12	.83	22	.99	-93	.16	-71	.59	28	

!NOISE PARAMETERS				
!F	FOPT	M[NO]	A[NO]	RN/50
3	0.7	.42	108	.072
4	0.8	.42	148	.072
5	0.95	.42	180	.072

Figure 7. S Parameters File for ATF-10236

!ATF-10736		S PARAMETERS			BIAS: Vds=2V, Ids=20mA				
!F	M[S11]	A[S11]	M[S21]	A[S21]	M[S12]	A[S12]	M[S22]	A[S22]	
2	.79	-74	4.48	111	.082	52	.33	-38	
3	.65	-108	3.85	85	.108	39	.25	-45	
4	.58	-145	3.37	59	.137	26	.15	-4B	
5	.54	175	2.90	34	.156	11	.05	-5	
6	.57	135	2.4B	9	.173	-3	.11	76	
7	.66	103	2.06	-12	.177	-17	.23	70	
B	.73	83	1.66	-30	.174	-28	.33	59	
9	.80	70	1.37	-45	.166	-37	.44	50	
10	.81	57	1.17	-59	.184	-44	.49	48	
11	.84	44	1.03	-72	.168	-53	.56	46	
12	.85	32	.94	-84	.164	-61	.58	41	

!NOISE PARAMETERS				
!F	FOPT	M[NO]	A[NO]	RN/50
3	1.0	.43	122	.042
4	1.1	.43	152	.042
5	1.25	.43	180	.042

Figure 8. S Parameters File for ATF-10736

The match for Q2 is established in a similar manner using the ATF-10736 S-parameters. The output of Q2 is conjugately matched for best gain, and the interstage between Q1 and Q2 is designed for both gain and stability. Stability of the amplifier should be checked at all frequencies where the stability factor k of the device used is less than 1.0. This means stability should be checked at frequencies below the band of operation as well as across the 3.7 – 4.2 GHz band. The entire match for the FET stages is then optimized using the Touchstone® program (Table 2.)

The noise parameters listed above correspond to a bias point of 2 V at 20 mA. A PNP active bias network (shown in Figure 9) is used to establish this bias point and to ensure that it remains constant over temperature. The bias current is set by R1 for Q1 and by R2 for Q2. A resistive divider sets the drain voltage. A DC converter circuit (shown in Figure 10) is used to provide the -5 volts needed for the gate bias.

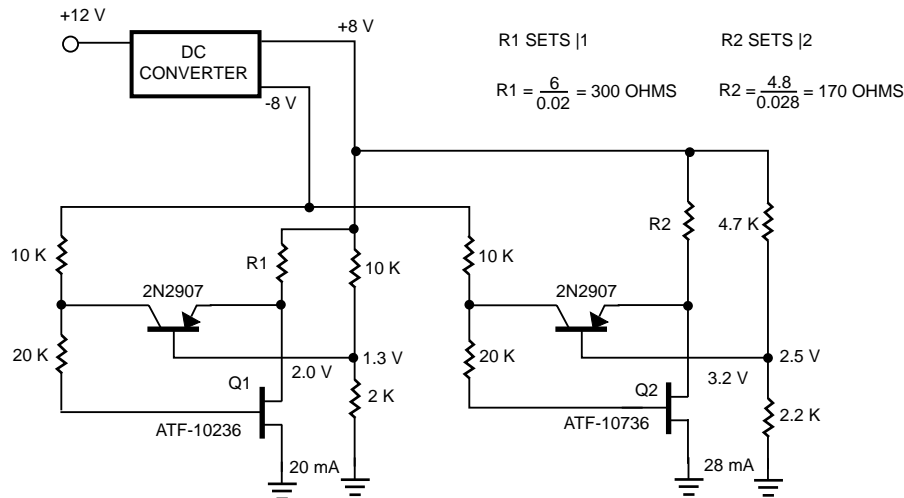


Figure 9. 3.7 - 4.2 GHz Low Noise Amplifier DC Schematic

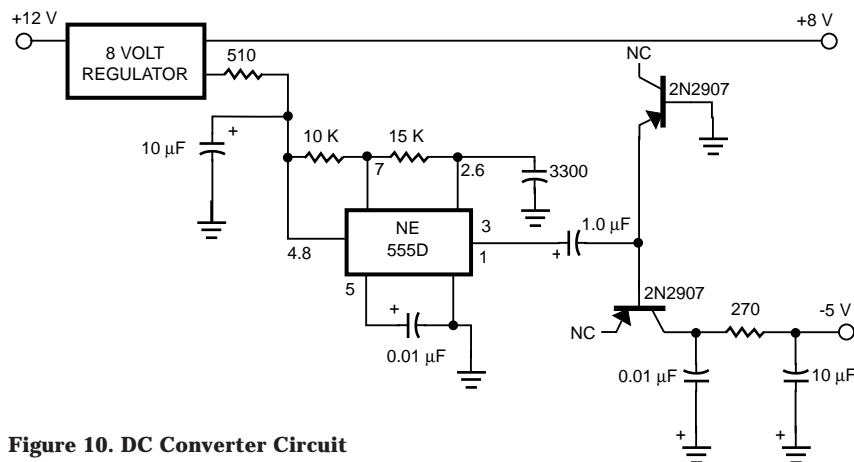


Figure 10. DC Converter Circuit

The bipolar transistor selected for use in stages 3 - 6 is the HP AT-41435. This device provides reasonable gain and noise performance at an economical cost and, like the ATF-10236 and ATF-10736, comes packaged in a glass sealed ceramic package for commercial applications. The first three stages are biased at 15 mA for current efficiency; the output stage is biased at 37 mA for power out. As with the FETs, an active bias circuit using PNP transistors is used to ensure the stability of the bias point over temperature. The DC bias circuit used is shown in Figure 11.

The match for the bipolar stages is established in a similar manner to that of the FET stages. Using the data sheet S-parameters, a single device is conjugately matched to achieve maximum flat gain and minimum reflected power. Two such stages are then cascaded, and the interstage is reoptimized for stability and flat gain. This match is then "step and repeated" until all four stages are incorporated. Remember that the S-parameters used for the first 3 stages use the 8 V, 10 mA data, while the output stage design uses the 8 V, 25 mA data. Once again the design is optimized using the Touchstone program (Table 2).

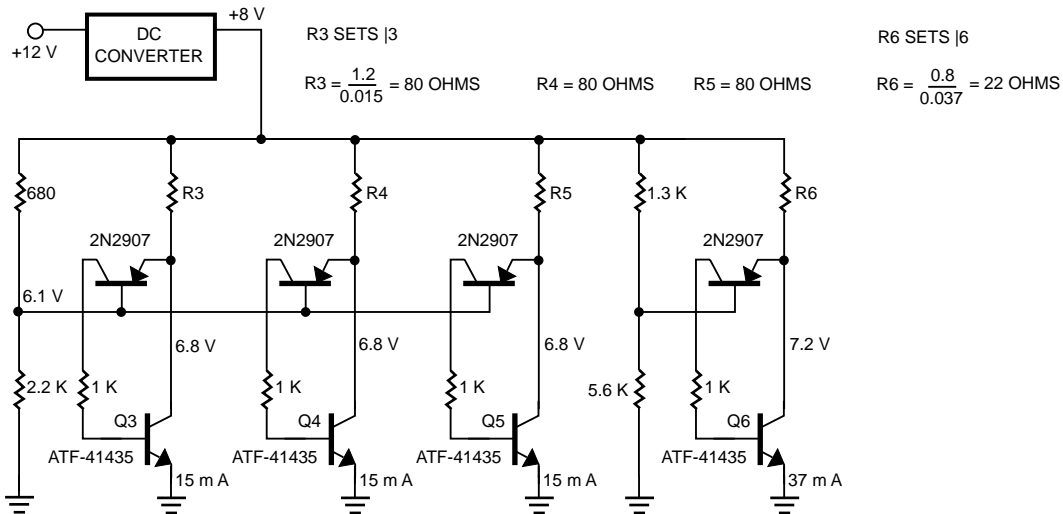


Figure 11. 3.7 - 4.2 GHz Low Noise Amplifier DC Schematic

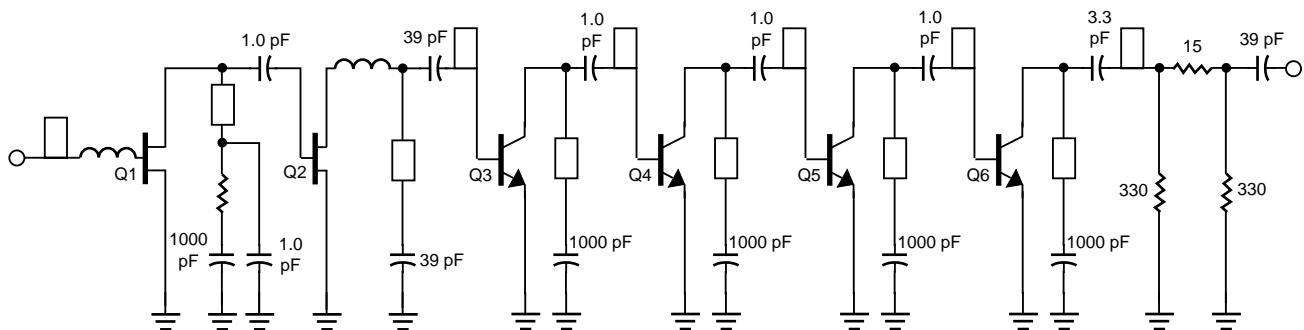


Figure 12. 3.7 - 4.2 GHz Low Noise Amplifier RF Schematic

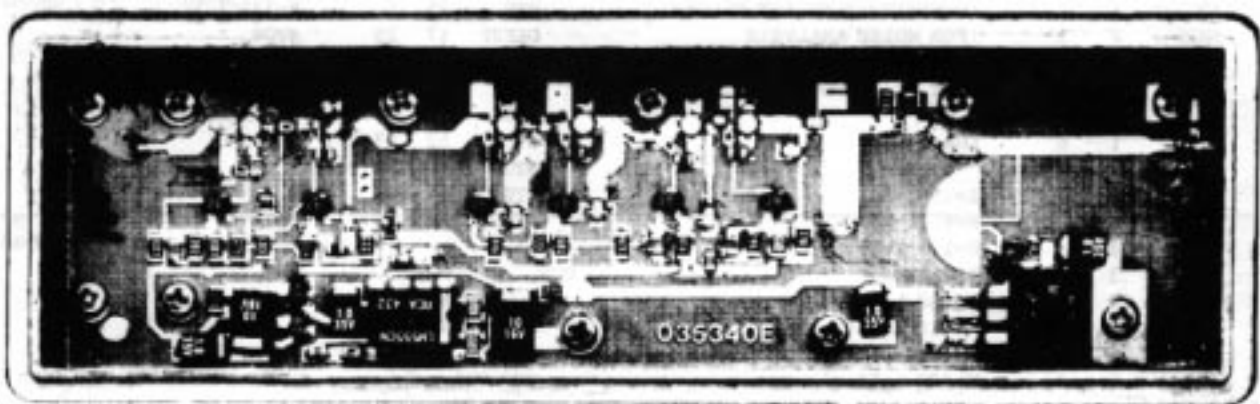


Figure 13. 4 GHz Low Noise Amplifier, Gain = 52 dB

The entire RF schematic for the final LNA is shown in Figure 12. The assembled RF and DC circuits are shown in Figure 13. In this photo the RF input is in the upper left corner, and the RF output and the DC input are in the upper right corner. The upper part of the circuitry is the RF path; the lower portion of the circuit is the DC path.

Performance

The Touchstone file describing the entire LNA is shown in Figure 14. (The S-parameter files ATF-10236 and ATF-10736 are given in Figures 7 and 8, respectively. The S-parameter files AT-41435A and AT-41435B are on the HP product disk supplied with Touchstone.) The predicted performance of the amplifier is shown in Figure 15. This simulation predicts a minimum gain of 54 dB and a maximum noise temperature of 70 K.

```

CKT
MSUB ER=2.56 H=31 T=1.0 RHO=1.0 RGH=0
SLC 11 13 L=.5 C=1 !3RD BIPOLAR
MLIN 1 2 W=80 L=.01 !1ST FET STG MLIN 13 14 W=80 L=170
MLIN 2 3 W=80 L=.01 S2PC 14 15 0
MLOC 3 W=80 L=275 MLIN 15 16 W=80 L=18
IND 3 4 L=1.4 MLIN 16 27 W=35 L=400
DEF2P 1 4 NAIN SLC 27 0 L=.5 C=1000
S2PA 4 5 0 ATF10236 MLIN 16 17 W=80 L=32
DEF2P 4 5 NA2P DEF2P 11 17 STG3
MLIN 5 6 W=30 L=80 SLC 17 18 L=.5 C=1 !4TH 8IPOLAR
MLIN 6 61 W=10 L=250 MLIN 18 19 W=80 L=65
SRC 61 0 R=50 C=1000 !2ND FET STG MLOC 19 W=65 L=50
SLC 61 0 L=.5 C=1 S2PD 19 20 0 AT41435B
SLC 6 7 L=.5 C=1 MLIN 20 21 W=80 L=200
MLIN 7 8 W=30 L=40 MLIN 21 28 W=35 L=85
DEF2P 5 8 NBIN SLC 28 0 L=.5 C=1000
S2PB 8 9 0 ATF10736 SLC 21 22 L=.5 C=3.3
DEF2P 8 9 NB2P MLOC 22 W=125 L=100
IND 9 10 L=1.9 MLIN 22 23 W=80 L=100
MLIN 10 101 W=20 L=250 MLSC 23 W=100 L=500
SLC 101 0 L=.5 C=39 MLIN 23 24 W=80 L=175
DEF2P 9 10 NBOUT RES 24 0 R=330
RES 24 25 R=15
RES 25 0 R=330
NAIN 1 2 !CONNECTION OF FET STAGES DEF2P 17 25 STG4
NA2P 2 3 !FOR NOISE ANALYSIS
NBIN 3 4 !(NOISE ANALYSIS ON
NB2P 4 5 !FET STAGES ONLY)
NBOUT 5 6
DEFZP 1 6 LNA
LNA 50 51 !CONNECTION OF
STG1 51 52 !ENTIRE AMPLIFIER
STG2 52 53
STG3 53 54
STG4 54 55
DEF2P 50 55 TOT
SLC 1 2 L=.5 C=39 !1ST BIPOLAR
MLIN 2 3 W=80 L=395
MLOC 3 W=110 L=135
S2PC 3 4 0 AT41435A OUT
MLIN 4 5 W=100 L=55 TOT D8[S21] GR1
MLIN 5 25 W=110 L=150 LNA D8[NF] GR2
SLC 25 0 L=.5 C=1000 TOT K
MLIN 5 6 W=100 L=55 TOT S11
DEF2P 1 6 STG1 TOT S22
SLC 6 7 L=.5 C=1 !2ND BIPOLAR FREQ
MLIN 7 8 W=65 L=100 SWEEP 1 5 .5
MLOC 8 W=110 L=135 SWEEP 3.7 4.2 .1
S2PC 8 9 0 GRID
MLIN 9 10 W=80 L=80 GR1 0 70 10
MLIN 10 26 W=90 L=200 RANGE 3.5 4.5 .1
SLC 26 0 L=.5 C=1000 GR2 0 2 ..2
MLIN 10 11 W=80 L=115
DEF2P 6 11 STG2

```

Figure 14. Touchstone Description of 4 GHz LNA

FREQ-GHz	DB[S21] TOT	DB[NF] TOT	K MAGS [S11] TOT	ANG[S11] TOT	MAG[S22] TOT	ANG[S22] TOT	
1.00000	8.466	1.654	9.0E+10	0.903	-71.832	0.521	72.499
1.50000	30.748	1.461	4.9E+07	0.869	-94.731	0.504	176.117
2.00000	48.475	1.331	1.1E+05	0.825	-119.373	0.470	131.093
2.50000	51.910	1.179	1.1E+04	0.682	-147.856	0.429	99.092
3.00000	52.532	1.047	3.4E+03	0.367	-158.040	0.325	67.371
3.50000	52.448	0.964	668.141	0.487	-151.330	0.133	57.614
3.70000	54.221	0.928	240.015	0.561	-172.611	0.124	87.100
3.80000	55.230	0.912	145.879	0.563	171.231	0.154	94.484
3.90000	56.086	0.899	99.250	0.510	150.730	0.195	92.928
4.00000	56.306	0.892	83.601	0.376	128.752	0.234	84.879
4.10000	55.697	0.901	82.668	0.214	118.998	0.263	73.398
4.20000	54.243	0.923	91.025	0.192	137.177	0.274	61.266
4.50000	48.318	1.131	103.915	0.655	45.952	0.263	25.803
5.00000	29.053	2.356	417.708	0.956	-78.409	0.230	-50.487

Figure 15. Output of Touchstone Analysis

Figure 16 compares the measured gain performance of a typical assembled amplifier to that predicted by the simulation. Figure 17 compares its noise performance to that of the simulation. Note that the gain of the actual amplifier is between 52 and 54 dB and its noise temperature is between 75 and 80 K. The difference between measured and calculated performance is due primarily to circuit losses, which for the sake of simplicity were assumed to be zero throughout the simulation. Although the figures describe the performance of a typical amplifier, it should be noted that noise performance of less than 65 K across the band has been achieved from this design. Note also that the higher cost HP ATF-10136 GaAs FET with 0.5 dB typical noise figure is available for use in stages 1 and 2 if desired.

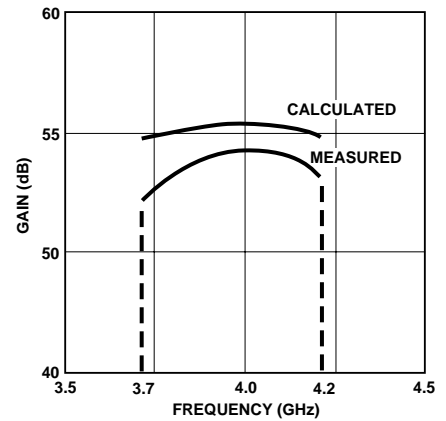


Figure 16. Gain vs. Frequency Low Noise Amplifier

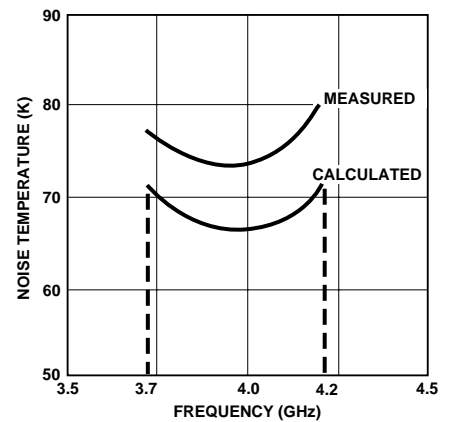


Figure 17. Noise Temperature vs. Frequency Low Noise Amplifier

Substituting in equation 1:

$$g_0 \left(\frac{R_e}{R_s} \right)^2 - \frac{4\pi^2 R_s}{T^2} = 0$$

Solving for R_s gives:

$$R_s = \sqrt[3]{(g_0 T^2 R_e^2) / (4\pi^2)} \quad \text{Eq. 6}$$

Substituting the values $g_0 = 32.2 \text{ ft/sec}^2 = 79,036 \text{ mi/hr}^2$

$T = 24 \text{ hours}$ (since the orbit is geosynchronous)

$R_e = 3963 \text{ miles}$

gives: $R_s = 26,270 \text{ miles}$.

The distance to the satellite in the plane of the equator at the longitude of the satellite is therefore:

$$R_s - R_e = 26,270 - 3963 = 22,307 \text{ miles.}$$

This is the minimum distance from the earth to the satellite.

From trigonometry, the slant range, r , to the satellite is given by:

$$r^2 = R_s^2 + R_e^2 - 2 R_s R_e \cos\theta \quad \text{Eq. 7}$$

where θ and r are defined in Figure 18.

As an example, for Satcom 4 satellite at longitude 83° West the calculation for Santa Clara, California is as follows:

Latitude for Santa Clara $\cong 37^\circ$.

Longitude for Santa Clara $\cong 122^\circ$.

From trigonometry, $\theta \cong 51^\circ$

Therefore:

$$\begin{aligned} r^2 &= 26,270^2 + 3963^2 - 2(26,270)(3963)(0.6293) \\ &= (690.1 + 15.7 - 131.0) \times 10^6 \\ &= 574.8 \times 10^6 \end{aligned}$$

$$\begin{aligned} r &= 23,975 \text{ miles} \\ &= 38,559 \text{ km.} \end{aligned}$$

The free space attenuation encountered by a satellite broadcasting from this orbit can be calculated from:

$$L_s = 20 \log \frac{4\pi r}{\lambda} \text{ dB} \quad \text{Eq. 8}$$

where λ = wavelength

$$\text{at 4 GHz, } \lambda \text{ free space} = \frac{C}{f} = \frac{3 \times 10^8 \text{ m/sec}}{4 \times 10^9 \text{ sec}^{-1}} = 0.075 \text{ meters}$$

L_s is therefore given by:

$$\begin{aligned} L_s &= 20 \log \frac{4\pi(38.559 \times 10^3)}{0.075} \text{ dB} \\ &= 196.2 \text{ dB} \end{aligned}$$

www.hp.com/go/rf

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